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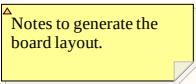
Sheet 6: SENSING

Legend

General comment such as function title, configuration, ...

Text to be added to silkscreen.

Warning text.



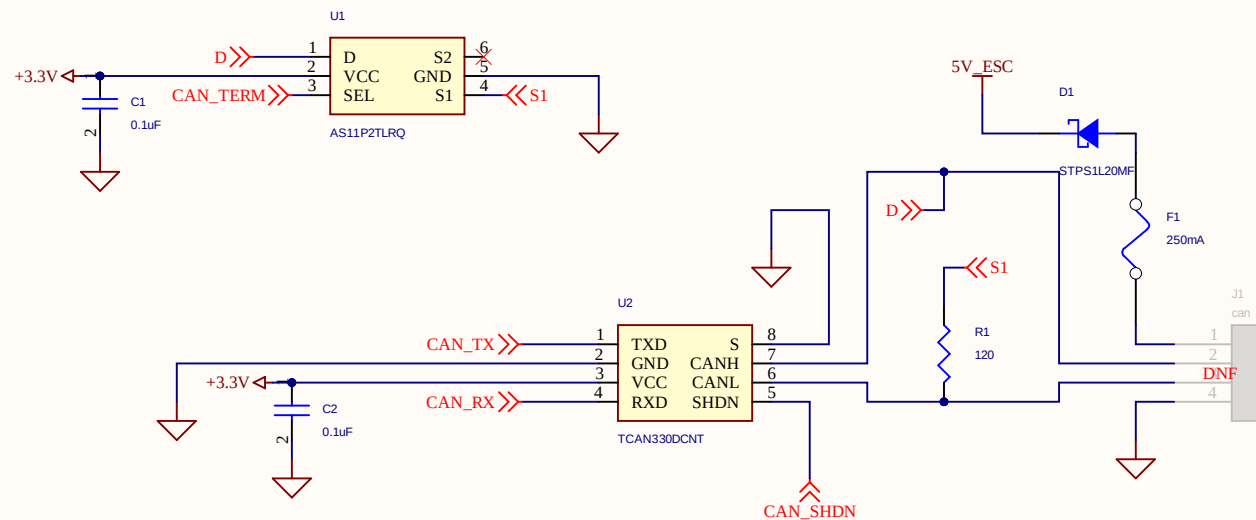
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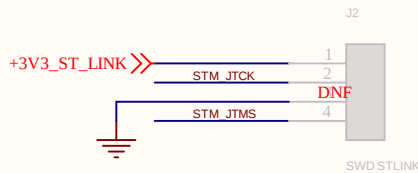
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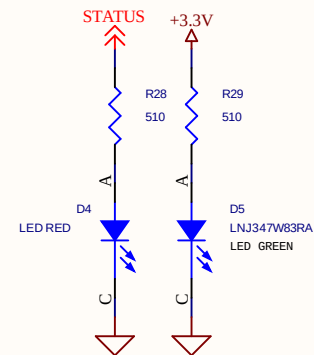
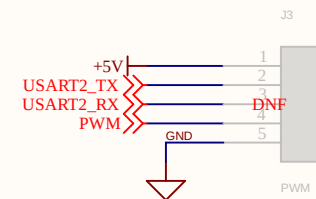
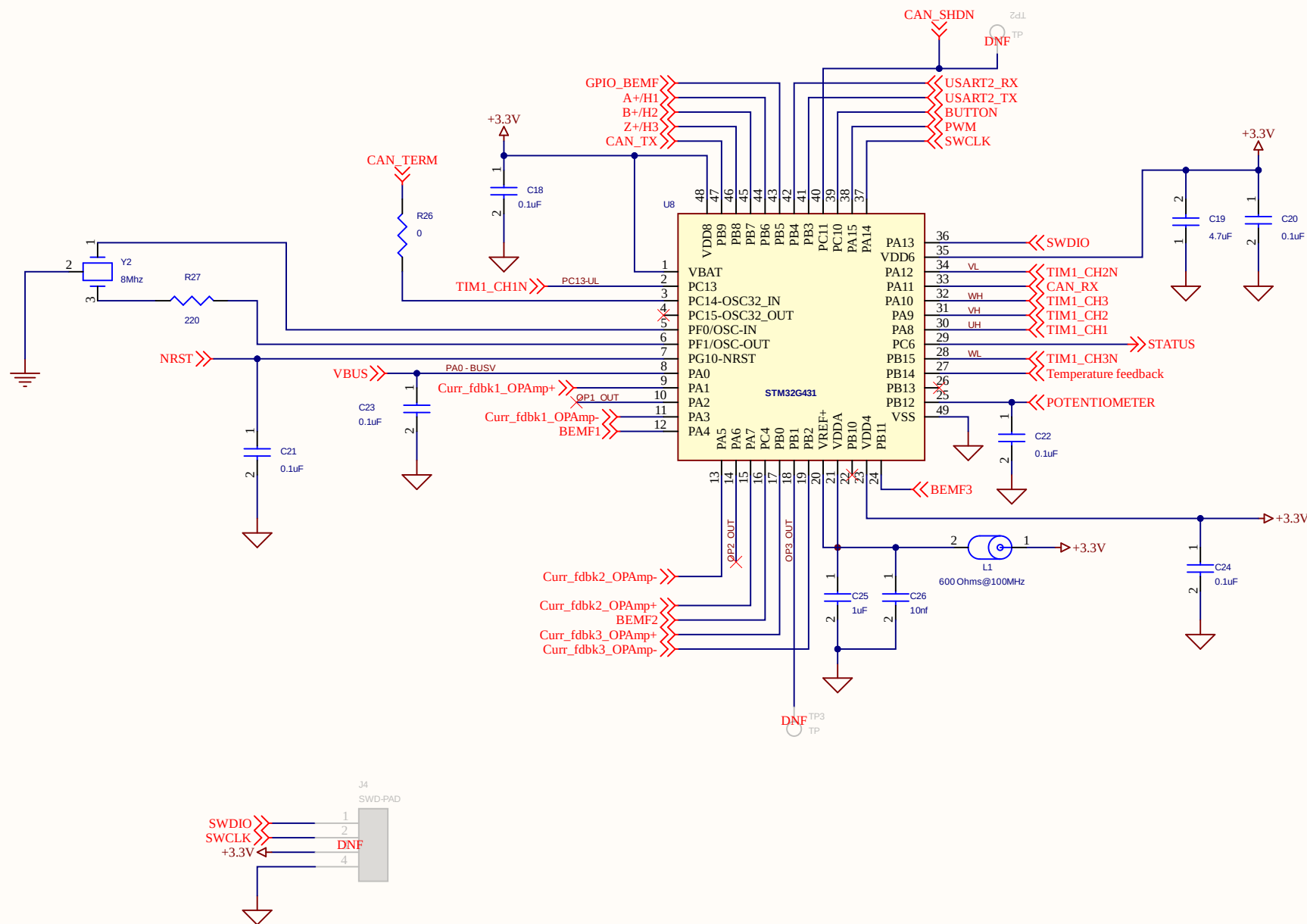
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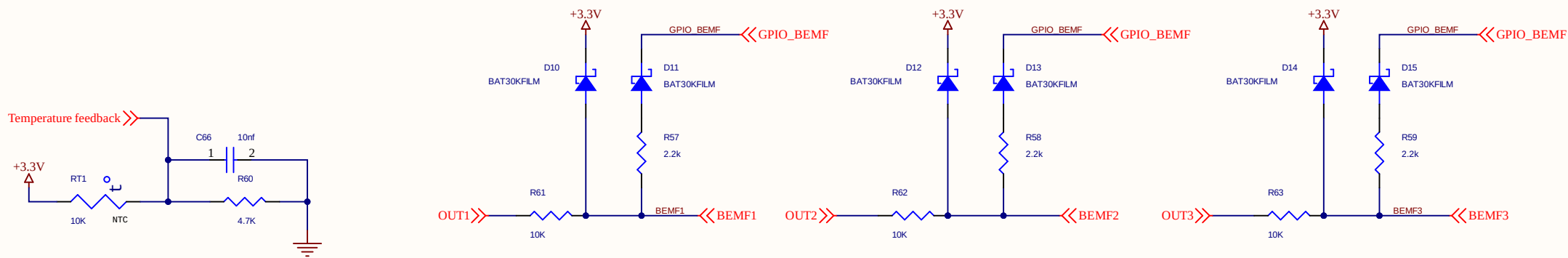
Title: Daughterboard		
Project: ESC_G4		
Variant: G431CBU6		
Revision: C-01		Reference: MB1419
Size: A3	Date: 18-FEB-2021	Sheet: 3 of 6



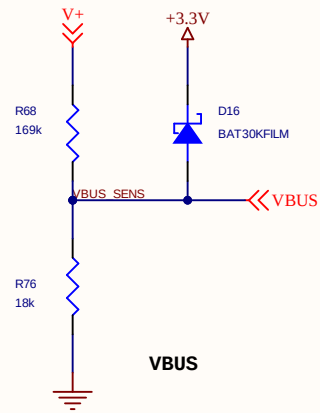
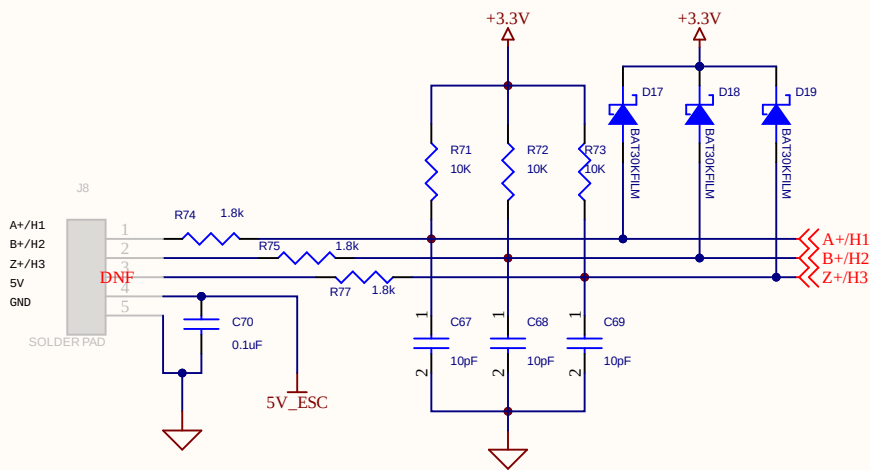


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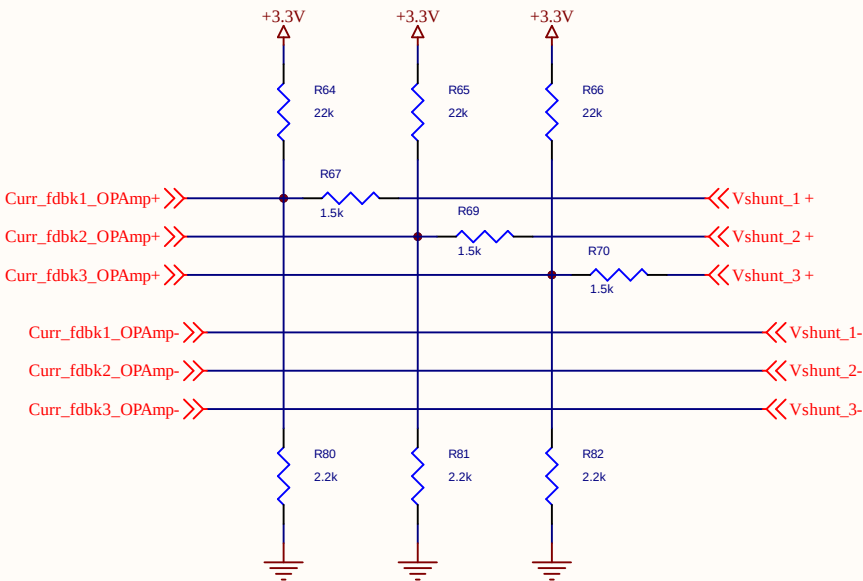
BEMF DETECTION- SIX STEP



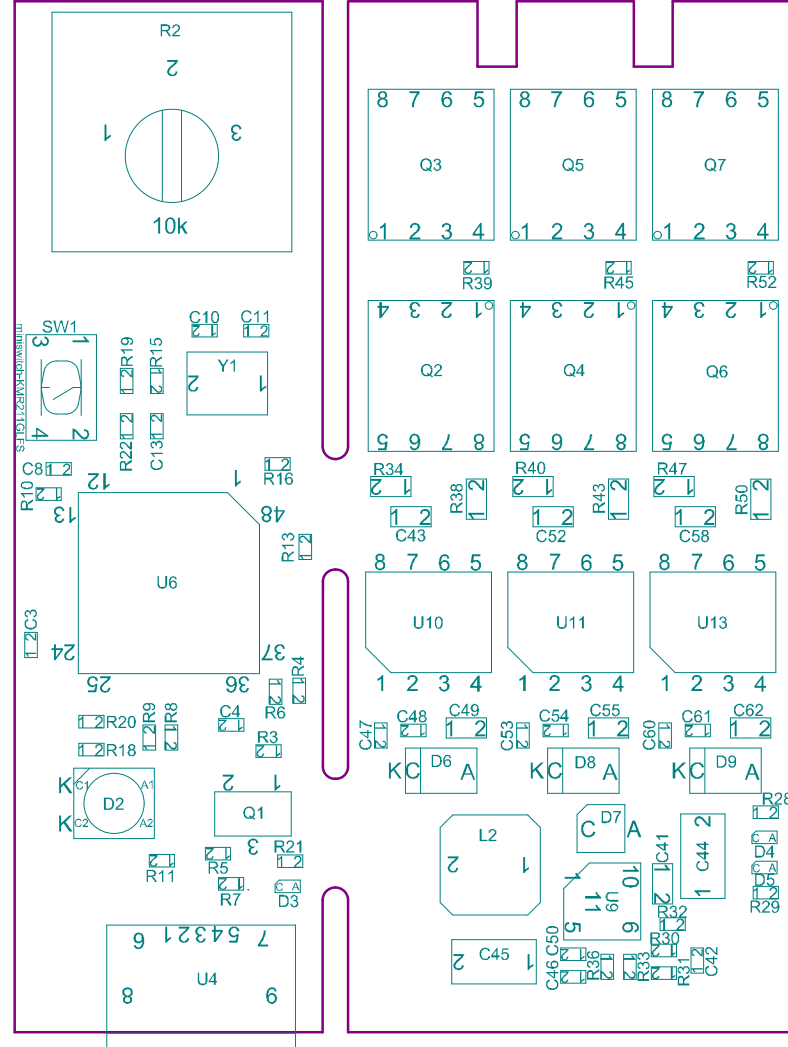
HALL/ENCODER SENSOR



SHUNT SENSING CIRCUIT



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Project: ESC_G4	
Layer: M14-Top Assembly	Gerber: .GM14
Variant: G431CBU6	Ref: MB1419
Date: 18-FEB-2021	Rev: C



